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CX2 Dual-Speed Connector System >

The CX2 Dual-Speed Connector System is a near-ASIC (near-chip) product that supports 224 Gbps PAM-4 signal speeds and enables BiPass cable system architecture at next-generation data rates.

FEATURES AND ADVANTAGES

Offers reduced cross talk (improved signal integrity, or SI) necessary for 224G signal speeds

Design ensures high-speed performance with excellent SI and minimal signal degradation

Improves reliability and helps precent mis-mating and accidental disconnection by ensuring full connector seating every time

The two-piece mated set of connector and socket features mechanical wipe and screw retention

Enables maximum system performance and greater reach within the box

Uses larger-gauge 29 AWG high-performance twinax cable

| Speed | Up to 224 Gbps |
|-----------------------|--------------------------------------|
| Current | 0.5A (per mated contact) |
| Number of Circuits | 32 differential pairs (DPs) |
| Pitch | 4.00mm DP to DP 2.30mm row to row |
| Durability | 50 cycles |
| Operating Temperature | -40 to +85°C |

Ensures next-generation high-speed performance using 224G channel

Isolated Tx/Rx with innovative shielding structure and high-performance twinax cable

Minimizes risk of pin damage on PCB connector during installation Fully protected "thumb-proof" mating interface









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MARKETS AND APPLICATIONS

Server and Storage

Data centers Servers and machine learning Computing

Networking

Ethernet-based communications Artificial intelligence (Al) Al clusters Al infrastructure

Telecommunications

Servers Routers Switches (ToR, Fabric)







Data Centers

Ethernet-Based Communications

Routers

SPECIFICATIONS

Reference Information

Series: 223767 (cable assembly) 223782 (socket) Packaging: Embossed tape with cover Designed in: Millimeters RoHS: Yes Halogen Free: Yes

Electrical

Voltage (max.): 29.9V AC RMS Current (max.): 0.5A per mated contact Dielectric Withstanding Voltage: 250V Insulation Resistance: 100 Megohms

Mechanical

Pitch: 4.00mm DP to DP 2.30mm row to row Mated Height: 16.60mm Width: 23.00mm Length: 34.00mm Circuit Size: 32 differential pairs Durability (max.): 50 cycles Mate Force (max.): 20 per pair Wrench Test (max.): 25N Screw Torque (max.): 0.65N-m Gatherability: 0.60mm

Physical

Housing: LCP Contact: Copper Alloy Plating: Contact Area—Gold Solder Tail Area—Tin Underplating—Nickel Operating Temperatures: -40 to +85°C

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